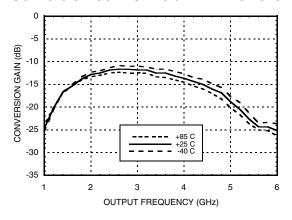


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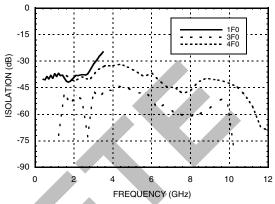


GaAs MMIC SMT PASSIVE FREQUENCY DOUBLER, 0.85 - 2.0 GHz INPUT

Conversion Gain @ +15 dBm Drive Level

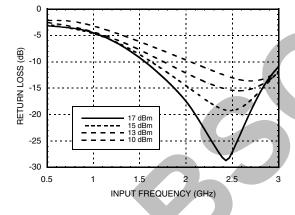


Isolation @ +15 dBm Drive Level*

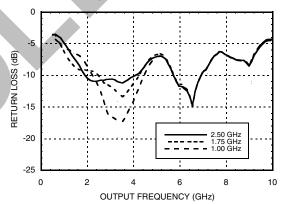


*With respect to input level

Input Return Loss vs. Drive Level



Output Return Loss for Several Input Frequencies



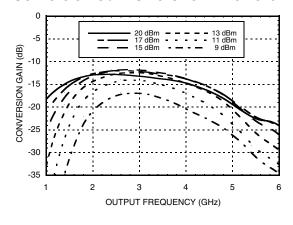


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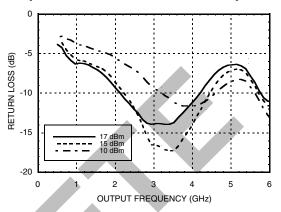


GaAs MMIC SMT PASSIVE FREQUENCY DOUBLER, 0.85 - 2.0 GHz INPUT

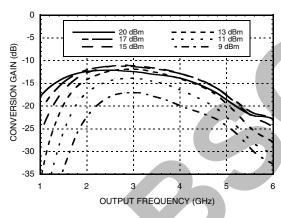
Conversion Gain @ 25°C vs. Drive Level



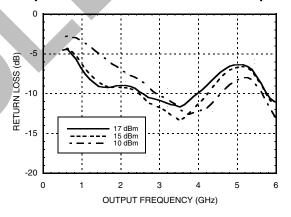
Output Return Loss with 1 GHz Input



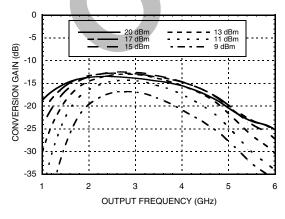
Conversion Gain @ -40°C vs. Drive Level



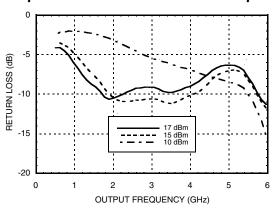
Output Return Loss with 1.75 GHz Input



Conversion Gain @ +85°C vs. Drive Level



Output Return Loss with 2.5 GHz Input



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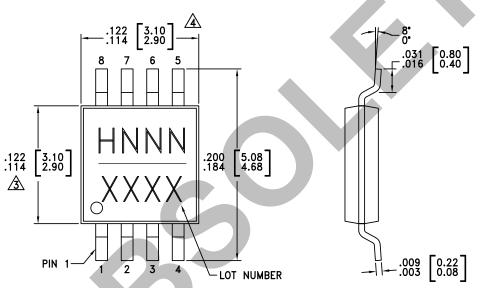
GaAs MMIC SMT PASSIVE FREQUENCY DOUBLER, 0.85 - 2.0 GHz INPUT

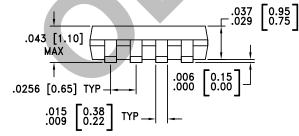
Absolute Maximum Ratings

| Input Drive | +27 dBm | |
|-----------------------|----------------|--|
| Storage Temperature | -65 to +150 °C | |
| Operating Temperature | -40 to +85 °C | |



Outline Drawing





NOTES:

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
- DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
- 5. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

Package Information

| Part Number | • | Package Body Material | Lead Finish | MSL Rating | Package Marking [3] |
|-------------|----|--|---------------|------------|---------------------|
| HMC187AMS | 8 | Low Stress Injection Molded Plastic | Sn/Pb Solder | MSL1 [1] | H187A XXXX |
| HMC187AMS | BE | RoHS-compliant Low Stress Injection Molded Plastic | 100% matte Sn | MSL1 [2] | H187A XXXX |

- [1] Max peak reflow temperature of 235 $^{\circ}\text{C}$
- [2] Max peak reflow temperature of 260 $^{\circ}\text{C}$
- [3] 4-Digit lot number XXXX

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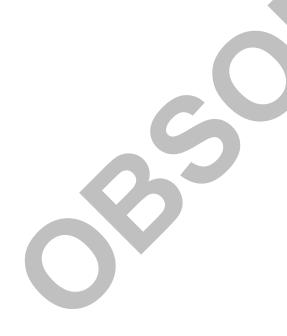
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GaAs MMIC SMT PASSIVE FREQUENCY DOUBLER, 0.85 - 2.0 GHz INPUT

Pin Description

| Pin Number | Function | Description | Interface Schematic |
|------------|----------|--|---------------------|
| 1, 4, 5, 8 | N/C | These pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/DC ground externally. | |
| 3, 6 | GND | All ground leads must be soldered to PCB RF/DC ground. | GND |
| 2 | RFIN | Pin is DC coupled and matched to 50 Ohms. | RFIN O |
| 7 | RFOUT | Pin is DC coupled and matched to 50 Ohms. | RFOUT |



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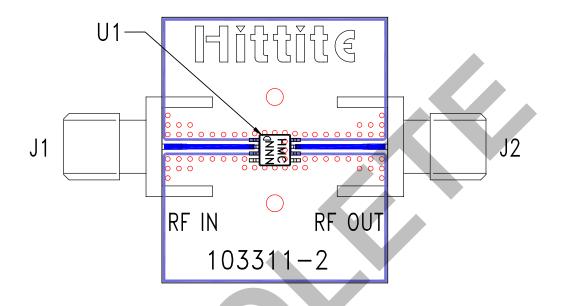


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GaAs MMIC SMT PASSIVE FREQUENCY DOUBLER, 0.85 - 2.0 GHz INPUT

Evaluation PCB



List of Materials for Evaluation PCB 103313 [1]

| Item | Description |
|---------|-------------------------|
| J1, J2 | PCB Mount SMA Connector |
| U1 | HMC187AMS8(E) Doubler |
| PCB [2] | 103311 Eval Board |

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should be generated with proper RF circuit design techniques. Signal lines should have 50 ohm impedance while the package N/C and ground leads should be connected directly to the ground plane similar to that shown. The evaluation circuit board shown is available from Hittite upon request.